

S/N 09/259,849

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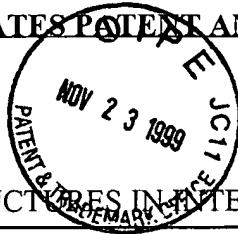
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

NOV 8 1999 4

Applicant: Paul A. Farrar
Serial No.: 09/259,849
Filed: March 1, 1999
Title: CONDUCTIVE STRUCTURES IN INTEGRATED CIRCUITS

Examiner: Group 2700
Group Art Unit: 1765
Docket: 303.557US1



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5/4/00

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 *et. seq.*, the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicant respectfully requests that this Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicant further request that a copy of the 1449 form, initialed by the Examiner to indicate that all listed citations have been considered, be returned with the next official communication.

Under 37 C.F.R. § 1.97(b)(3), it is believed that no fee or certificate is required with this Information Disclosure Statement. However, if an Office Action on the merits has been mailed, the Commissioner is hereby authorized to charge any additional fees or credit any overpayment to Account No. 19-0743.

The Examiner is invited to contact the Applicant's Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

PAUL A. FARRAR

By his Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.
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Minneapolis, MN 55402
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Date November 16, 1999 By Danny J. Radys
Danny J. Radys
Reg. No. 35,635

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Assistant Commissioner of Patents, Washington, D.C. 20231 on November 16, 1999.

Name

Cinda Bone

Signature

Cinda Bone

S/N 09/259,849

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Applicant: Paul A. Farrar

Examiner:

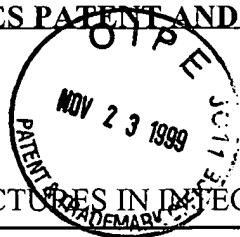
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COMMUNICATION CONCERNING CO-PENDING APPLICATION(S)

Assistant Commissioner for Patents

Washington, D.C. 20231

Applicant would like to bring to the Examiner's attention the following related co-pending application(s) in the above-identified patent application:

<u>Serial No.</u>	<u>Filing Date</u>	<u>Attorney Docket</u>	<u>Title</u>
09/032,197	02/27/1998	00303.459US1	METHODS FOR MAKING COPPER AND OTHER METAL INTERCONNECTIONS IN INTEGRATED CIRCUITS
09/128,859	08/04/1998	00303.473US1	COPPER METALLURGY IN INTEGRATED CIRCUITS
09/145,012	09/01/1998	00303.505US1	INTEGRATED-CIRCUIT WITH OXIDATION-RESISTANT POLYMERIC LAYER
09/256,123	02/24/1999	00303.505US2	FORMING SUBMICRON INTEGRATED-CIRCUIT WIRING FROM GOLD, SILVER, COPPER AND OTHER METALS

COMMUNICATION CONCERNING CO-PENDING APPLICATIONS

Serial Number: 09/259,849

Filing Date: March 1, 1999

Title: CONDUCTIVE STRUCTURES IN INTEGRATED CIRCUITS

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09/256,124 02/24/1999 00303.505US3

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INTEGRATED-CIRCUIT WIRING FROM
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METALS

Respectfully submitted,

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By Applicant's Representatives,

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Date November 16, 1999

By



Danny J. Padys
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Name

Gina Borie

Signature

Gina Borie